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Power MOSFET

TO-220AB S N-Channel MOSFET

PRODUCT SUMMA	RY	
V _{DS} (V)	500)
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	0.21
Q _g max. (nC)	110)
Q _{gs} (nC)	33	
Q _{gd} (nC)	54	
Configuration	Sing	le

FEATURES

- · Low gate charge Qg results in simple drive requirement
 - RoHS
- Improved gate, avalanche, and dynamic dV/dt ruggedness
- Fully characterized capacitance and avalanche voltage and current
- Low R_{DS(on)}
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

APPLICATIONS

- Switch mode power supply (SMPS)
- Uninterruptible power supply
- · High speed power switching
- · Hard switched and high frequency circuits

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRFB20N50KPbF

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, un	less otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	500	v
Gate-source voltage			V _{GS}	± 30	V
Captinuous durin surrent	V _{GS} at 10 V	T _C = 25 °C	1	20	
Continuous drain current	VGS at 10 V	T _C = 100 °C	ID	12	А
Pulsed drain current ^a			I _{DM}	80	
Linear derating factor				2.2	W/°C
Single pulse avalanche energy ^b			E _{AS}	330	mJ
Repetitive avalanche current ^a			I _{AR}	20	А
Repetitive avalanche energy ^a			E _{AR}	28	mJ
Maximum power dissipation	T _C =	25 °C	PD	280	W
Peak diode recovery dV/dt ^c			dV/dt	10	V/ns
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	*0
Soldering recommendations (peak temperature) ^d	For	10 s		300	°C
Mounting torque	6-32 or	M3 screw		10	N

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. Starting T_J = 25 °C, L = 1.6 mH, R_g = 25 Ω , I_{AS} = 20 A
- c. $I_{SD} \le 20$ A, dI/dt ≤ 350 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C
- d. 1.6 mm from case

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THERMAL RESISTANCE RAT	INGS							
PARAMETER	SYMBOL	TYP	·-	MAX.			UNIT	
Maximum junction-to-ambient	R _{thJA}	-		58				
Case-to-sink, flat, greased surface	R _{thCS}	0.50)	-			°C/W	
Maximum junction-to-case (drain)	R _{thJC}	-		0.45				
			•					
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$,	unless otherw	vise noted)						
PARAMETER	SYMBOL	1		ONS	MIN.	TYP.	MAX.	UNIT
Static		1				1		
Drain-source breakdown voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 2	50 µA	500	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	$I_D = 1 \text{ mA}$	-	0.61	-	V/°C
Gate-source threshold voltage	V _{GS(th)}		= V _{GS} , I _D = 2		3.0	-	5.0	V
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 30$ V		-	-	± 100	nA
	_		= 500 V, V _{GS}		-	-	50	
Zero gate voltage drain current	I _{DSS}			T _J = 125 °C	-	-	250	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V		= 12 A ^b	-	0.21	0.25	Ω
Forward transconductance	9 _{fs}	V _{DS}	= 50 V, I _D =	12 A	11	-	-	S
Dynamic	•	1				•		
Input capacitance	C _{iss}		V _{GS} = 0 V,		-	2870	-	
Output capacitance	C _{oss}		$V_{GS} = 0.0,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5		-	320	-	pF
Reverse transfer capacitance	C _{rss}	f = 1			-	34	-	
Output series iterate		V _{DS} =		V, f = 1.0 MHz	-	3480	-	
Output capacitance	C _{oss}	$V_{GS} = 0 V$	$V_{DS} = 400$	V, f = 1.0 MHz	-	85	-	
Effective output capacitance	C _{oss} eff.		$V_{DS} = 0$	0 V to 400 V	-	160	-	
Total gate charge	Qg				-	-	110	
Gate-source charge	Q _{gs}	$V_{GS} = 10 V$	$I_D = 20 A$	0 A, V _{DS} = 400 V fig. 6 and 13 ^b	-	-	33	nC
Gate-drain charge	Q _{gd}		See lig	. o and to	-	-	54	
Turn-on delay time	t _{d(on)}				-	22	-	
Rise time	t _r		= 250 V, I _D =		-	74	-	ns
Turn-off delay time	t _{d(off)}	$R_g = 7.5 \Omega$,	$V_{GS} = 10 V,$	see fig. 10 ^b	-	45	-	
Fall time	t _f	1		-	33	-		
Gate input resistance	R _g	f = 1	MHz, open	drain	0.3	-	2.9	Ω
Drain-Source Body Diode Characteris	tics							
Continuous source-drain diode current	I _S	showing the			-	-	20	_
Pulsed diode forward current ^a	I _{SM}	integral revers p - n junction			-	-	80	A
Body diode voltage	V _{SD}	T _J = 25 °C	, I _S = 20 A, '	V _{GS} = 0 V ^b	-	-	1.5	V
Body diode reverse recovery time	t _{rr}	T 05 00 1	00 4 -11/	H 100 4/ - h	-	520	780	ns
Body diode reverse recovery charge	Q _{rr}	$I_{\rm J} = 25 {}^{\circ}{\rm C}, I_{\rm F}$	= 20 A, dl/c	lt = 100 A/µs ^b	-	5.3	8.0	μC
Forward turn-on time	t _{on}	Intrinsic tu	ırn-on time i	s negligible (turn	-on is dor	ninated b	y L _S and	L _D)

Notes

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a. Repetitive rating; pulse width limited by maximum junction temperature

b. Pulse width \leq 400 µs; duty cycle \leq 2 %

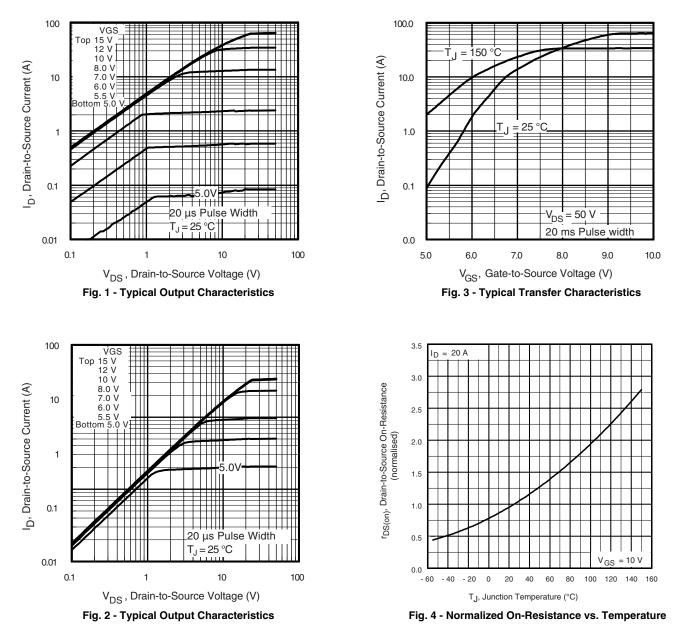


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3 For technical questions, contact: <u>hvm@vishay.com</u>

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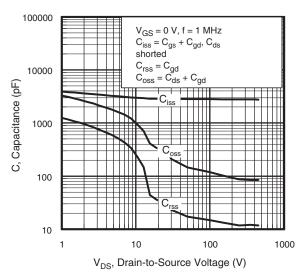


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

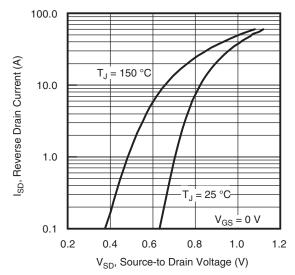


Fig. 7 - Typical Source-Drain Diode Forward Voltage

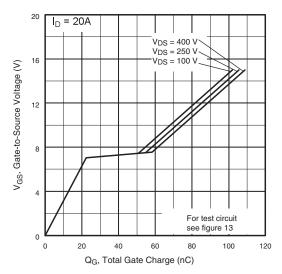


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

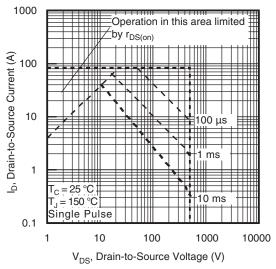
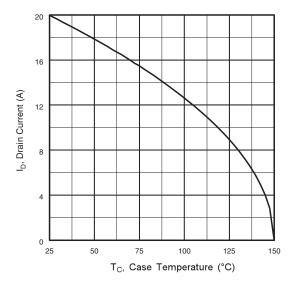


Fig. 8 - Maximum Safe Operating Area

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Fig. 9 - Maximum Drain Current vs. Case Temperature

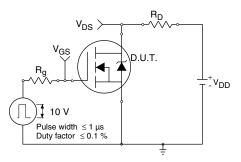


Fig. 10a - Switching Time Test Circuit

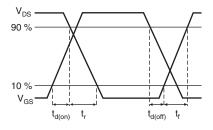
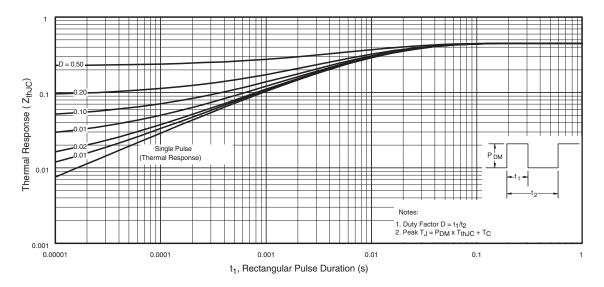


Fig. 10b - Switching Time Waveforms





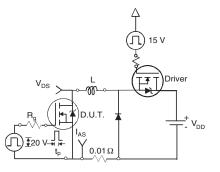


Fig. 12a - Unclamped Inductive Test Circuit

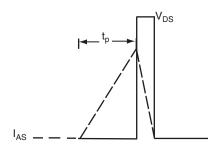


Fig. 12b - Unclamped Inductive Waveforms

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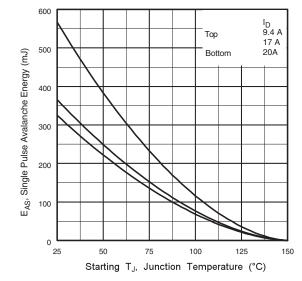


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

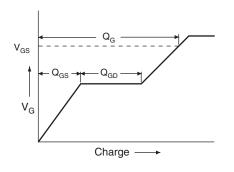


Fig. 13a - Basic Gate Charge Waveform

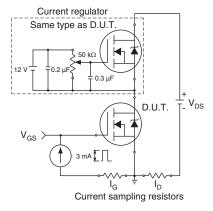
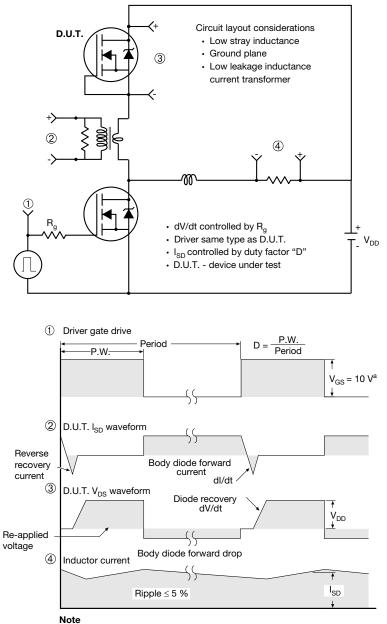


Fig. 13b - Gate Charge Test Circuit



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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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TO-220-1



DIM	MILLIN	IETERS	INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØP	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

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